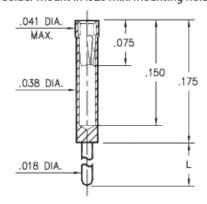


DATA SHEET

Product Number: 0461-2-15-80-21-27-04-0

0461-X-15-XX-X1-XX-04-0

Solder mount in .020 min. mounting hole



Basic Part Number	Length L
0461-0	.400
0461-1	.275
0461-2	.180
0461-3	.125
0461-4	.060
0461-5	.440
	I

Description:

0461 - Receptacle With A Standard Tail Accepts .015" (0.38mm) - .022" (0.56mm) diameter leads.

Packaging:

Packaged in Bulk

Mill-Max Part Number	Shell Plating	Contact Plating	RoHS Compliant
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#21 CONTACT FOR .015"-.022" DIAMETER PINS (δ = .004, 3-FINGER, GROUP A (See page 248)

PRECISION MACHINED SHELL (CUSTOM DESIGNS WELCOME)

0461-2-15-80-21-27-04-0

 $200 - 300 \mu$ " Tin (matte finish) over Nickel

30 μ" Gold over Nickel

CONTACT MATERIAL BERYLLIUM COPPER

Alloy 172, Heat Treated



CONTACT:

Contact Used: #21, Low Force 3 Finger Contact

Current Rating = 3 Amps

BERYLLIUM COPPER ALLOY 172 (UNS C17200) per

ASTM B 194

Properties of BERYLLIUM COPPER:

- $_{\bullet}$ Chemical composition: Cu 98.1%, Be 1.9%
- Temper as stamped: TD01
- Properties after heat treatment (TH01):
- Hardness: 36-43 Rockwell C
- Mechanical Life: 1000 Cycles Min.
- Density: .298 lbs/in3
- Electrical Conductivity: 22% IACS*
- Resistance: 10 miliohms Max
- Operating Temperature: -55°C/+125°C
- Melting point: 980°C/865°C (liquidus/solidus)
- Stress Relaxation†: 96% of stress remains after 1,000 hours @ 100 °C; 70% of stress remains after 1,000 hours @ 200 °C

†Since BeCu loses its spring properties over time at high temperatures; it is rated for continuous use up to 150°C. For applications up to 300°C, Mill-Max offers many contacts in Beryllium Nickel. Contact Tech Support for more info.

SHELL MATERIAL:

^{*}International Annealed Copper Standard, i.e. as a % of pure copper.

BRASS ALLOY (UNS C36000) per ASTM B 16

Properties of BRASS ALLOY:

Chemical composition: Cu 61.5%, Zn 35.4%, Pb 3.1%†

Hardness as machined: 80-90 Rockwell B

• Density: .307 lbs/in3

• Electrical conductivity: 26% IACS*

Melting point: 900°C/885°C (liquidus/solidus)

†(3 to 4% lead is used to permit "free machining" and is permitted by EC Directive 2002/95Annex 6; so all pin materials are RoHS compliant)

*International Annealed Copper Standard, i.e. as a % of pure copper.

Certificate of Compliance:

This is to Certify that the product described above is manufactured to Mill-Max quality standards in accordance with all applicable specifications and drawing. Mill-Max certifies this product to be free from defects of materials and workmanship.

This Certificate of Compliance covers the following requirements:

- Dimensional (all features verified to be within tolerances described on the applicable drawing).
- Raw Material (materials and properties verified to be as described on the applicable drawing).
 Plating (platings as required, thickness verified, and performance including solderability per mil-standard).
 Performance (insertion extraction or other force requirements as described on the applicable drawing).

RoHS Compliance Statement for the restriction of lead, mercury, cadmium and hexavalent chromium PBB, PBDE, including Octa-BDE, Penta-BDE, Deca -BDE, in electronic equipment and use of PFOA and PFOS in metal plating processes.

Reference:

- 1. Directive 2002/95/EC of the European Parliament and of the Council of January 27 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.
- 2. Directive 2003/11/EC which amends Council Directive 76/769/EC to include pentabromodiphenyl ether and octabromodiphenyl ether.
- 3. Directive 2005/618/EC Commission decision of 18 August 2005 amending Directive 2002/95/EC. Establishes threshold limits for Lead, Mercury, Cadmium, Hexavalent Chromium, PBB, and PBDE.
- 4. Judgment of the Court (Grand Chamber) 1 April 2008, Directive 2002/95/EC-Electrical and electronic equipment Decabromodiphenyl ether (Deca-BDE) Actions for annulment of exemption.
- 5. EU Directive 2006/122/EC of the European Parliament and of the Council of 12 December 2006, amending Council Directive 76/769/EEC on the restriction of Perfluorocatanoic Acid (PFOA) and Perfluorocatane Sulfanates (PFOS) used during metal plating processes.

In reference to the directives described above, MILL-MAX Mfg.Corp. declares that lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls, polybrominated diphenyl ethers, including pentabromodiphenyl ether, octabromodiphenyl ether, decabromodiphenyl ether, Perfluorooctanoic Acid, and Perfluorooctane Sulfanates are not intentionally added to the raw material or processes used for our certified RoHS compliant products except where described and allowed under item 6 of the annex; Applications where lead mercury, cadmium, and hexavalent chromium, which are exempted from the requirements of Article 4 (1) of reference 1. No warranty, liability of indemnification is expressed or implied with this information.

Compliance Statement for Registration, Evaluation, Authorization and Restriction of Chemicals (REACH)

Reference:

- 1. Regulation EC No 1907/2006 of the European Parliament and of the Council of 18 December 2006, concerning the Registration, Evaluation, Authorization and Restriction of Chemicals (REACH)
- 2. ECHA, Candidate list of Substances of Very High Concern (SVHC) http://echa.europa.eu/reach_en.asp

Mill-Max is aware of the regulation and the SVHC list the EU published (referenced above). Mill-Max does not produce or sell any of the listed substances in their homogeneous form. These substances are not intentionally added during the manufacturing of any Mill-Max products. To our knowledge, our products do not contain the substances described on the ECHA SVHC list. Testing is not performed for materials and substances that were not intentionally added. No warranty, liability of indemnification is expressed or implied with this information. Mill-Max maintains surveillance of the ECHA website to obtain the latest information and periodically reviews the SVHC list for changes and additions.

Compliance Statement for DRC Conflict Free products.

Reference:

Dodd-Frank Wall Street Reform and Consumer Protection Act, Section 1502, reporting requirements for users of conflict

"Conflict minerals," are Columbite-tantalite (coltan), cassiterite, gold, wolframite, or their derivatives; or any other mineral or its derivatives determined by the Secretary of State to be financing conflict in the Democratic Republic of the Congo (DRC) or an adjoining country. Metals derived from these minerals are tin, tantalum, tungsten, and gold. By this definition, the only minerals of concern that may be found in Mill-Max products are tin and gold.

Mill-Max Mfg.Corp. hereby certifies that its products are manufactured with tin and gold that is derived from material that is considered DRC Conflict Free. Mill-Max provides this assurance as a result of a due diligence process that includes traceability to the source and in some cases the identification of recycled and scrap materials included in the subject material.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Contact Probes category:

Click to view products by Mill-Max manufacturer:

Other Similar products are found below:

CT5253 CT5082 100039-033-958 100077-003-0-0 300122-031-1102 R-2-RP-375 S-4-C-5-G S/C 300122-056-0203 SS-75-B-2.4-G S-100-U-10-G-S SS-75-C-4.9-D D/C .620 OAL 100165-033-952 100024-002-942 SS-75-E-4.9-D D/C .620 OAL SX-0-U-2.2-G D/C 101740-028-948 ICT-100-V8-8-G S/C ICT-075-B-10-G-S S/C S-2-D-8.3-G D/C S-2-D-10-G D/C GSS-19-7-G S/C OAL ICT-100-T-8-G S/C GSS-4-7-G S-0-B9-2.5-G S/C SS-40-J-2.4-G D/C S-0-A-2.2-D 660 S/C SS-50-J-3.3-D S/C S-0-V-3.7-G S/C SX-2-B-7-G D/C SX-1-U-6.6-G D/C SX-1-C-6.6-G D/C SS-75-D-4.9-D D/C .620 OAL SS-50-E-2.9-G S/C SS-40-J-1.8-G-N/L D/C SS-3-7-G S/C W/HOLE .373 OAL SS-18-7-G S/C W/HOLE .373 OAL SS-18-7-G S/C W/HOLE .385 OAL SHE-5-H-18.7-G SHE-5-B-18.7-G SHE-5-A-18.7-G SHE-3-A-7-G SH-4-A-10-G S/C 101057-001-952 S-50C-HS-4.3-DG-S S-5-F-8-G S/C SS SPGS S-5-F-16.4-G S/C S-4-K-5-G S/C S-4-E-5-D S/C S-2-J-8.3-G D/C